

P03349-US div
CLO.004 DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re divisional patent application of 10/298,228 filed on November 18, 2002

Masahiro Nakano et al.

Serial No.: Not Yet Assigned

Group Art Unit: Not Yet Assigned

Filing Date: Concurrently Herewith

Examiner: Unknown

For: PACKAGING SUBSTRATE AND MANUFACTURING METHOD THEREOF,
INTEGRATED CIRCUIT DEVICE AND MANUFACTURING METHOD
THEREOF, AND SAW DEVICE

Honorable Commissioner of Patents
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Please amend the above-identified application as follows:

INTRODUCTORY COMMENTS

Amendments to the Claims begin on page 2 of this paper. Claims 1-28 have been canceled. No new matter has been added.

Remarks begin on page 3 of this paper.